

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China









Is Now Part of



ON Semiconductor®

To learn more about ON Semiconductor, please visit our website at www.onsemi.com

ON Semiconductor and the ON Semiconductor logo are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does ON Semiconductor assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any EDA Class 3 medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, emplo



April 2016

HUFA76413DK8T_F085

N-Channel Logic Level UltraFET® Power MOSFET **60V**, **4.8A**, **56m** Ω

General Description

These N-Channel power MOSFETs are manufactured using the innovative UltraFET® process. This advanced process technology achieves the lowest possible onresistance per silicon area, resulting in outstanding performance. This device is capable of withstanding high energy

in the avalanche mode and the diode exhibits very low reverse recovery time and stored charge. It was designed for use in applications where power efficiency is important, such as switching regulators, switching convertors, motor drivers, relay drivers, low-voltage bus switches, and power management in portable and battery-operated products.

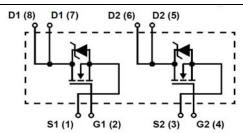


Features

- 150°C Maximum Junction Temperature
- UIS Capability (Single Pulse and Repetitive Pulse)
- Ultra-Low On-Resistance $r_{DS(ON)} = 0.049\Omega$, VGS = 10V
- Ultra-Low On-Resistance $r_{DS(ON)} = 0.056\Omega$, VGS = 5V
- Qualified to AEC Q101
- RoHS Compliant

Applications

- Motor and Load Control
- Powertrain Management





SO-8

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parameter	Ratings	Units
V_{DSS}	Drain to Source Voltage	60	V
V_{GS}	Gate to Source Voltage	±16	V
	Drain Current -Continuous (T _C = 25 °C, V _{GS} = 10V)	5.1	
	-Continuous (T _C = 25 °C, V _{GS} = 5V)	4.8	Α
ID	-Continuous (T_C = 125 °C, V_{GS} = 5V, $R_{\theta JA}$ = 228 °C/W)	1	
	-Pulsed	Figure 4	
E _{AS}	Single Pulse Avalanche Energy (Note 1)	260	mJ
D	Power Dissipation	2.5	W
P_{D}	Derate Above 25 °C	0.02	W/°C
T _J , T _{STG}	Operating and Storage Temperature	-55 to +150	°C

Thermal Characteristics

	$R_{ hetaJA}$	Thermal Resistance Junction to Ambient SO-8 (Note 2)	50	
		Thermal Resistance Junction to Ambient SO-8 (Note 3)	191	°C/W
		Thermal Resistance Junction to Ambient SO-8 (Note 4)	228	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
76413DK8	HUFA76413DK8T_F085	SO-8	330mm	12mm	2500 units

Notes:

- **1:** Starting $T_J = 25 \,^{\circ}\text{C}$, L = 20mH, $I_{AS} = 5.1\text{A}$
- 2: R_{0JA} is 50 °C/W when mounted on a 0.5 in² copper pad on FR-4 at 1 second.
- **3:** $R_{\theta JA}^{\circ}$ is 191 °C/W when mounted on a 0.027 in copper pad on FR-4 at 1000 seconds. **4:** $R_{\theta JA}^{\circ}$ is 228 °C/W when mounted on a 0.006 in copper pad on FR-4 at 1000 seconds.
- 5: A suffix as "...F085P" has been temporarily introduced in order to manage a double source strategy as Fairchild has officially announced in Aug 2014.

Electrical Characteristics T_J = 25°C unless otherwise noted

Symbol	Parameter	Test Conditions		Min	Тур	Max	Units	
Off Characteristics								
BV_{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} =$	0 V	60	-	-	V	
l	Zero Gate Voltage Drain Current	$V_{DS} = 55 V$,		-	-	1	μΑ	
DSS		$V_{GS} = 0 V$	T _A = 150 °C	-	-	250	μΑ	
I_{GSS}	Gate to Source Leakage Current	$V_{GS} = \pm 16 \text{ V}$		-	-	±100	nA	

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	1	-	3	V
r _{DS(on)}	Static Drain to Source On Resistance	I _D = 5.1 A, V _{GS} = 10 V	-	0.041	0.049	
		I _D = 4.8 A, V _{GS} = 5 V	-	0.048	0.056	Ω
		I_D = 4.8 A, V_{GS} = 5 V, T_A = 150 °C	-	0.091	0.106	

Dynamic Characteristics

C _{iss}	Input Capacitance	V 05.V.V	V _{DS} = 25 V, V _{GS} = 0 V, f = 1MHz		620	-	pF
C _{oss}	Output Capacitance				180	-	pF
C _{rss}	Reverse Transfer Capacitance	1 - 1101112			30	-	pF
$Q_{g(TOT)}$	Total Gate Charge at 10V	V_{GS} = 0 to 10 V		-	18	23	nC
$Q_{g(5)}$	Total Gate Charge at 5V	$V_{GS} = 0 \text{ to } 5 \text{ V}$	V _{GS} = 0 to 1 V I _D = 4.8 A,	-	10	13	nC
$Q_{g(TH)}$	Threshold Gate Charge	$V_{GS} = 0 \text{ to } 1 \text{ V}$		-	0.6	0.8	nC
Q_{gs}	Gate to Source Charge		$I_g = 1.0 \text{ mA}$	-	1.8	-	nC
Q_{gd}	Gate to Drain "Miller" Charge			-	5	-	nC

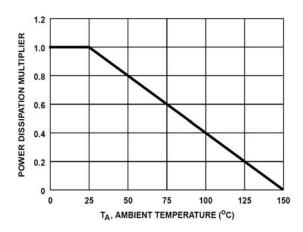
Switching Characteristics (V_{GS} =5V)

t _{on}	Turn-On Time		-	-	44	ns
t _{d(on)}	Turn-On Delay Time		-	10	-	ns
t _r	Rise Time	$V_{DD} = 30 \text{ V}, I_{D} = 1.0 \text{ A},$	-	19	-	ns
t _{d(off)}	Turn-Off Delay Time	V_{GS} = 5 V, R_{GS} = 16 Ω	-	45	-	ns
t _f	Fall Time		-	27	-	ns
t _{off}	Turn-Off Time		-	-	108	ns

Drain-Source Diode Characteristics

V_{SD}	Source to Drain Diode Forward Voltage	I _{SD} = 4.8 A	-	-	1.25	\	
		I _{SD} = 2.4 A	-	-	1.0] V	
t _{rr}	Reverse Recovery Time	-I _{SD} = 4.8 A, dI _{SD} /dt = 100 A/μs	-	-	43	ns	
Q _{rr}	Reverse Recovery Charge		-	-	55	nC	

Typical Characteristics T_J = 25°C unless otherwise noted



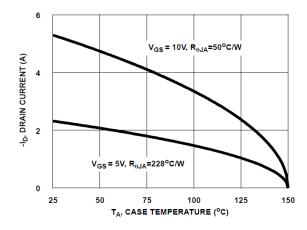


Figure 1. Normalized Power Dissipation vs. Ambient Temperature

Figure 2. Maximum Continuous Drain Current vs.

Case Temperature

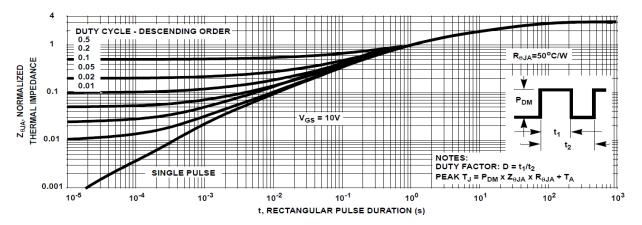


Figure 3. Normalized Maximum Transient Thermal Impedance

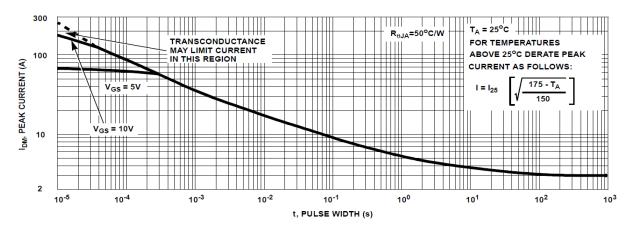


Figure 4. Peak Current Capability

Typical Characteristics $T_J = 25^{\circ}C$ unless otherwise noted

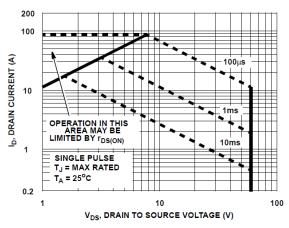
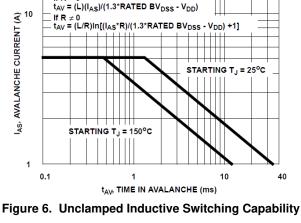


Figure 5. Forward Bias Safe Operating Area



15

If R = 0

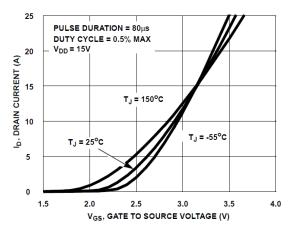


Figure 7. Transfer Characteristics

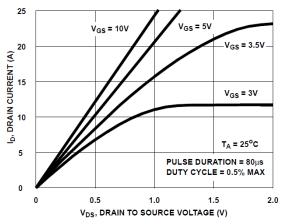


Figure 8. Saturation Characteristics

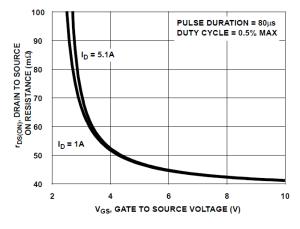


Figure 9. Drain to Source On Resistance vs. Gate Voltage and Drain Current

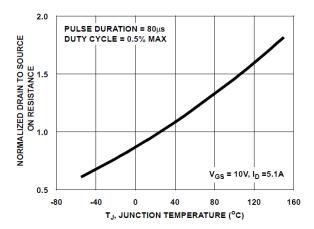


Figure 10. Normalized Drain to Source On Resistance vs. Junction Temperature

Typical Characteristics T_J = 25°C unless otherwise noted

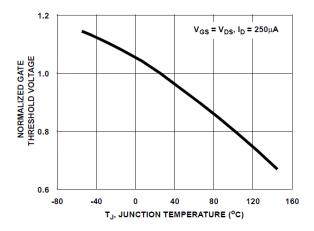


Figure 11. Normalized Gate Threshold Voltage vs. Junction Temperature

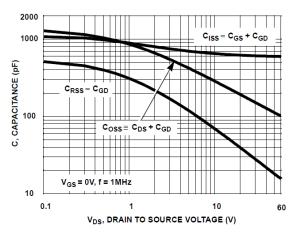


Figure 13. Capacitance vs. Drain to Source Voltage

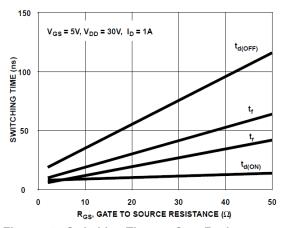


Figure 15. Switching Time vs Gate Resistance

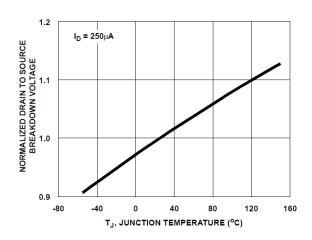


Figure 12. Normalized Drain to Source Breakdown Voltage vs. Junction Temperature

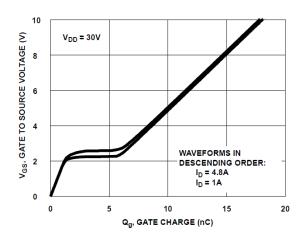
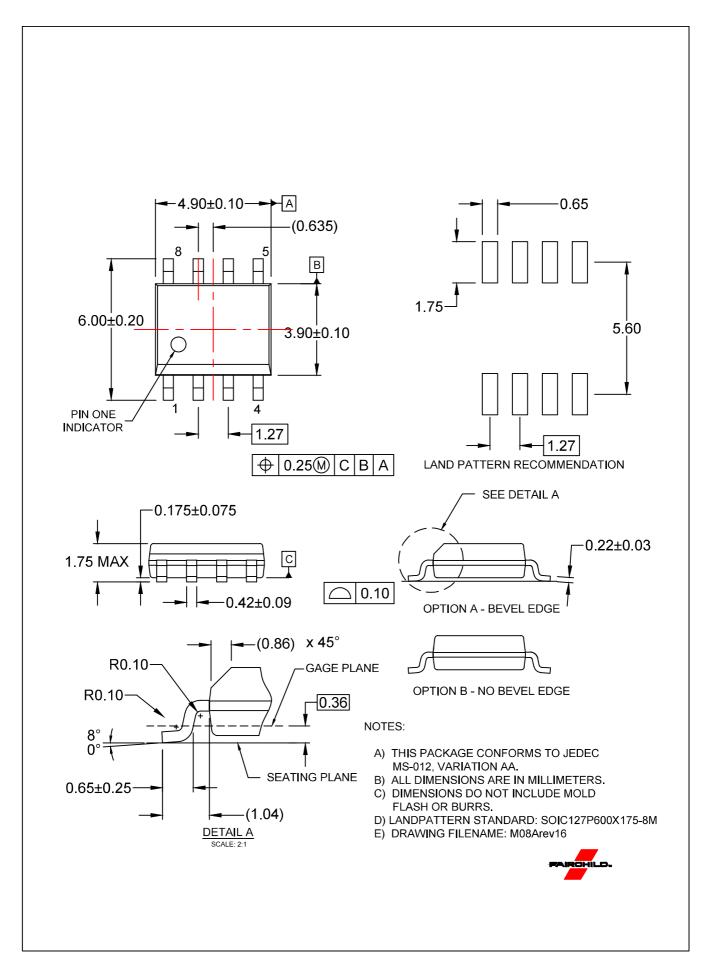


Figure 14. Gate Charge Waveforms for Constant Gate Currents



ON Semiconductor and are trademarks of Semiconductor Components Industries, LLC dba ON Semiconductor or its subsidiaries in the United States and/or other countries. ON Semiconductor owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of ON Semiconductor's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. ON Semiconductor reserves the right to make changes without further notice to any products herein. ON Semiconductor nessure any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using ON Semiconductor products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by ON Semiconductor. "Typical" parameters which may be provided in ON Semiconductor data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. ON Semiconductor does not convey any license under its patent rights nor the rights of others. ON Semiconductor products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use ON Semiconductor products for any such unintended or unauthorized application, Buyer shall indemnify and hold ON Semiconductor and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, a

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor 19521 E. 32nd Pkwy, Aurora, Colorado 80011 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada
Europe, Middle East and Africa Technical Support:
Phone: 421 33 790 2910
Japan Customer Focus Center
Phone: 81–3–5817–1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative